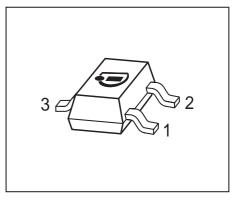


BF517

## **NPN Silicon RF Transistor**

- For amplifier and oscillator applications in TV-tuners
- Pb-free (RoHS compliant) package<sup>1)</sup>
- Qualified according AEC Q101





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration			Package
BF517	LRs	1 = B	2 = E	3 = C	SOT23

### **Maximum Ratings**

Parameter	Symbol	Value	Unit	
Collector-emitter voltage	V <sub>CEO</sub>	15	V	
Collector-base voltage	V <sub>CBO</sub>	25		
Emitter-base voltage	V <sub>EBO</sub>	2.5		
Collector current	I <sub>C</sub>	25	mA	
Peak collector current	/ <sub>CM</sub>	50		
Total power dissipation <sup>2)</sup>	P <sub>tot</sub>	280	mW	
<i>T</i> <sub>S</sub> ≤ 55 °C				
Junction temperature	T <sub>i</sub>	150	°C	
Ambient temperature	T <sub>A</sub>	-65 150		
Storage temperature	T <sub>stg</sub>	-65 150		

#### Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>3)</sup>	R <sub>thJS</sub>	≤ <b>340</b>	K/W

<sup>1</sup>Pb-containing package may be available upon special request

 $^2 {\it T}_S$  is measured on the collector lead at the soldering point to the pcb

<sup>3</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance



Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	15	-	-	V
$I_{\rm C} = 1  {\rm mA},  I_{\rm B} = 0$					
Collector-base cutoff current	I <sub>CBO</sub>				μA
$V_{\rm CB} = 10 \text{ V}, \ I_{\rm E} = 0$		-	-	0.05	
$V_{\rm CB} = 25  \text{V}, \ I_{\rm E} = 0$		-	-	10	
Emitter-base cutoff current	I <sub>EBO</sub>	-	-	100	
$V_{\rm EB} = 2.5 \text{ V}, \ I_{\rm C} = 0$					
DC current gain-	h <sub>FE</sub>				-
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 1 V, pulse measured		40	-	150	
$I_{\rm C}$ = 25 mA, $V_{\rm CE}$ = 1 V, pulse measured		20	70	-	
Collector-emitter saturation voltage	V <sub>CEsat</sub>	-	0.1	0.4	V
$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 1 mA					

# **Electrical Characteristics** at $T_A = 25^{\circ}$ C, unless otherwise specified

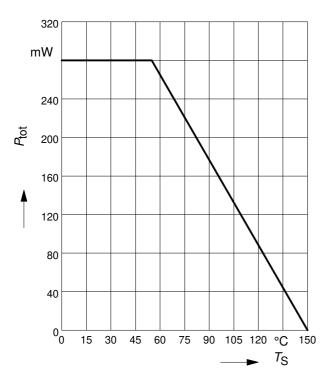


Symbol	Values			Unit
	min.	typ.	max.	
g)				
f <sub>T</sub>				GHz
	1	1.4	-	
	1.3	2.5	-	
C <sub>cb</sub>	-	0.55	0.8	pF
C <sub>ce</sub>	-	0.27	-	
C <sub>eb</sub>	-	0.9	1.45	
F	-	3.5	5	dB
$ S_{21e} ^2$	-	13	-	dB
IP <sub>3</sub>	-	21.5	-	dBm
P <sub>-1dB</sub>	-	10	-	-
	g) $f_{T}$ $C_{cb}$ $C_{ce}$ $C_{eb}$ F $ S_{21e} ^2$	min.   g) $f_T$ 1   1.3 $C_{cb}$ - $C_{ce}$ - $C_{eb}$ - $F$ - $ S_{21e} ^2$ - $IP_3$ -	min.typ.g) $f_T$ 111.41.32.5 $C_{cb}$ - $C_{cb}$ - $C_{ce}$ - $C_{eb}$ - $C_{eb}$ - $S_{21e} ^2$ - $IP_3$ - $21.5$	min.typ.max.g) $f_T$ 11.4-1.32.5- $C_{cb}$ -0.550.8 $C_{ce}$ -0.27- $C_{eb}$ -0.91.45 $F$ -3.55 $ S_{21e} ^2$ -13- $ P_3$ -21.5-

# **Electrical Characteristics** at $T_A = 25^{\circ}$ C, unless otherwise specified

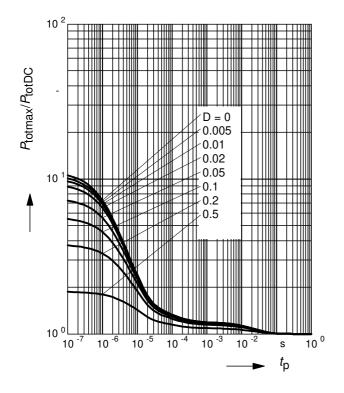


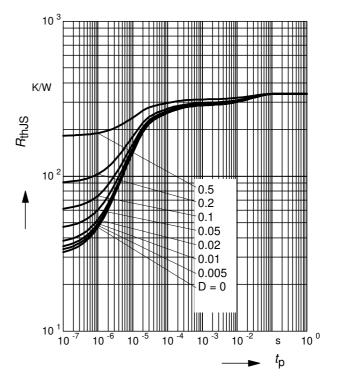
Total power dissipation  $P_{tot} = f(T_S)$ 



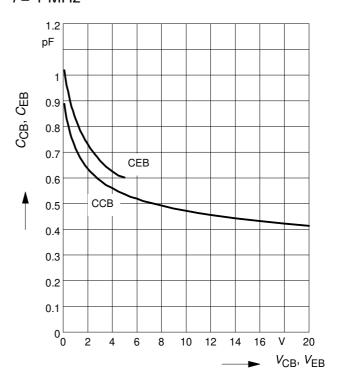
# Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$ 





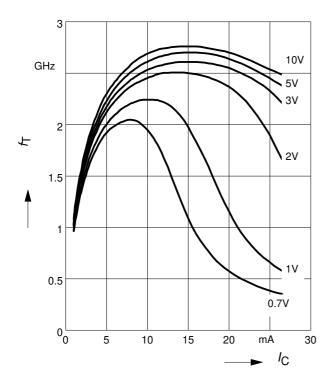
Collector-base capacitance  $C_{cb} = f(V_{CB})$ Emitter-base capacitance  $C_{eb} = f(V_{EB})$ f = 1 MHz



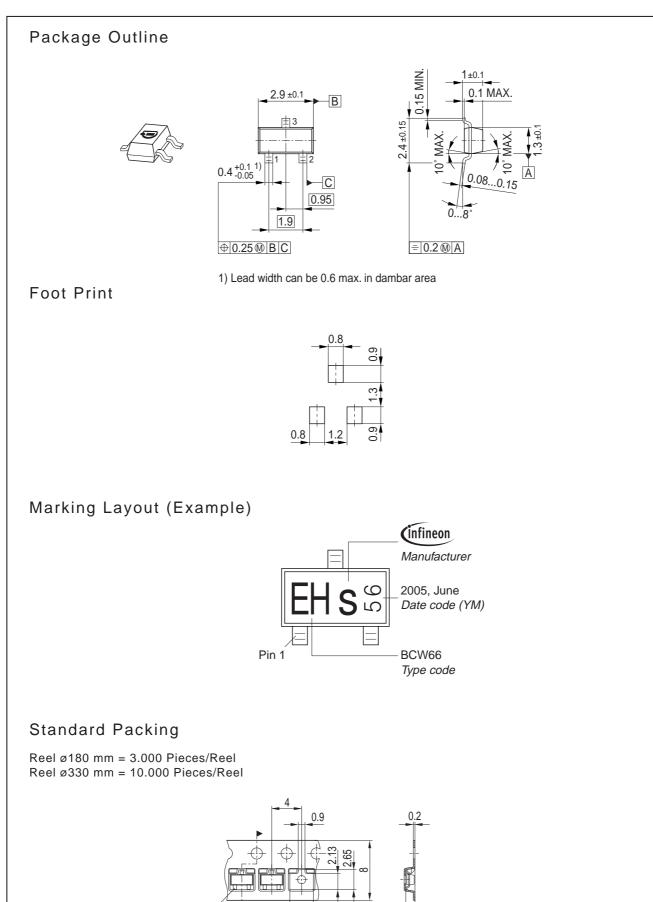


# Transition frequency $f_{\rm T} = f(I_{\rm C})$

 $V_{CE}$  = parameter







1.15

3.15

Pin 1



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